

Precision Monolithics Inc.

FEATURES

- Low Supply Current $55\mu\text{A}$ Max
- Single-Supply Operation $+5\text{V}$ to $+30\text{V}$
- Dual-Supply Operation $\pm 2.5\text{V}$ to $\pm 15\text{V}$
- Low Input Offset Voltage $250\mu\text{V}$ Max
- Low Input Offset Voltage Drift $1.5\mu\text{V}/^\circ\text{C}$ Max
- High Common-Mode Input Range V_- to V_+ (-1.5V)
- High CMRR and PSRR 100dB Min
- High Open-Loop Gain 120dB Min
- No External Components Required
- 741 Pinout and Nulling
- Available in Die Form

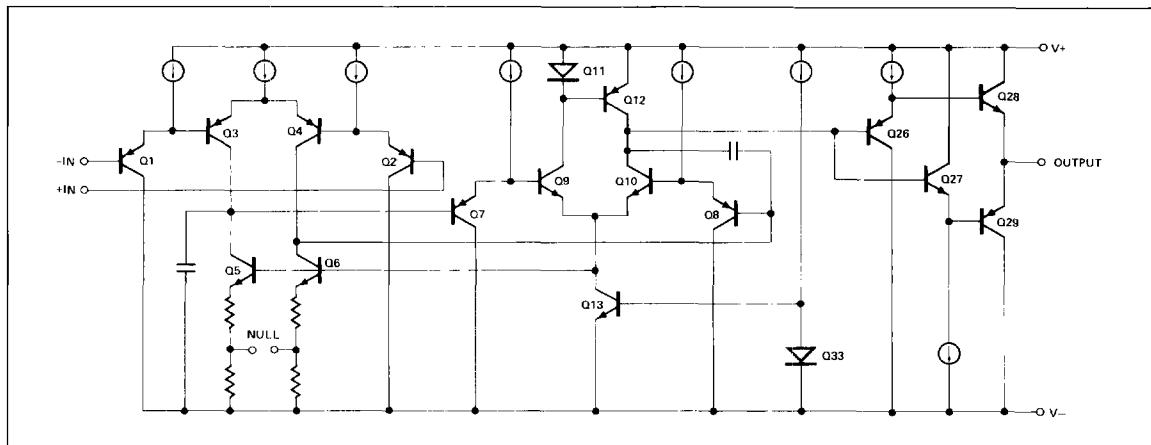
ORDERING INFORMATION [†]

$T_A = +25^\circ\text{C}$	PACKAGE	CERDIP	PLASTIC	OPERATING TEMPERATURE RANGE
V_{os} MAX (mV)	TO-99	8-PIN	8-PIN	
250	OP20BJ*	OP20BZ	—	MIL
250	OP20FJ	OP20FZ	—	IND
250	—	—	OP20FP	COM
500	—	OP20CZ	—	MIL
500	OP20GJ	OP20GZ	—	IND
500	—	—	OP20GP	COM
1000	OP20HJ	OP20HZ	OP20HS††	XIND
1000	—	—	OP20HP	XIND

* For devices processed in total compliance to MIL-STD-883, add /883 after part number. Consult factory for 883 data sheet.

† Burn-in is available on commercial and industrial temperature range parts in cerDIP, plastic DIP, and TO-can packages. For ordering information, see 1990/91 Data Book, Section 2.

†† For availability and burn-in information on SO and PLCC packages, contact your local sales office.

SIMPLIFIED SCHEMATIC

ABSOLUTE MAXIMUM RATINGS (Note 1)

Supply Voltage	$\pm 18V$
Differential Input Voltage	$\pm 30V$
Input Voltage	Supply Voltage
Output Short-Circuit Duration	Indefinite
Storage Temperature Range		
J and Z Packages	-65°C to +150°C
P Package	-65°C to +125°C
Operating Temperature Range		
OP-20B, OP-20C (J, Z)	-55°C to +125°C
OP-20F, OP-20G (J, Z)	-25°C to +85°C
OP-20H (S, P, J, Z)	-40°C to +85°C
OP-20FP, OP-20GP	0°C to +70°C
Lead Temperature Range (Soldering, 60 sec)	300°C
Junction Temperature	-65°C to +150°C

PACKAGE TYPE	Θ_{JA} (NOTE 2)	Θ_{JC}	UNITS
TO-99 (J)	150	18	°C/W
8-Pin Hermetic DIP (Z)	148	16	°C/W
8-Pin Plastic DIP (P)	103	43	°C/W
8-Pin SO (S)	158	43	°C/W

NOTES:

1. Absolute maximum ratings apply to both DICE and packaged parts, unless otherwise noted.
2. Θ_{JA} is specified for worst case mounting conditions, i.e., Θ_{JA} is specified for device in socket for TO, CerDIP and P-DIP packages; Θ_{JA} is specified for device soldered to printed circuit board for SO package.

ELECTRICAL CHARACTERISTICS at $V_S = \pm 2.5V$ to $\pm 15V$, $T_A = +25^\circ C$, unless otherwise noted.

PARAMETER	SYMBOL	CONDITIONS	OP-20B/F			OP-20C/G			OP-20H			UNITS
			MIN	Typ	MAX	MIN	Typ	MAX	MIN	Typ	MAX	
Input Offset Voltage	V_{OS}	$V_S = \pm 15V$	—	55	250	—	150	500	—	300	1000	μV
Input Offset Current	I_{OS}	$V_{CM} = 0$	—	0.15	1.5	—	0.2	2.5	—	0.3	4.0	nA
Input Bias Current	I_B	$V_{CM} = 0$	—	12	25	—	14	30	—	16	40	nA
Input Voltage Range	IVR	$V_+ = +5V$, $V_- = 0V$, $V_S = \pm 15V$	0/3.5	—	—	0/3.5	—	—	0/3.5	—	—	V
Common-Mode Rejection Ratio	CMRR	$V_+ = +5V$, $V_- = 0V$ $0V \leq V_{CM} \leq 3.5V$ $V_S = \pm 15V$ $-15V \leq V_{CM} \leq 13.5V$	95	105	—	90	95	—	85	90	—	dB
Power Supply Rejection Ratio	PSRR	$V_S = \pm 2.5V$ to $\pm 15V$ and $V_- = 0V$, $V_+ = 5V$ to $30V$	—	4	6	—	6	10	—	10	32	$\mu V/V$
Large-Signal Voltage Gain	A _{VO}	$V_+ = +5V$, $V_- = 0V$ $1V \leq V_O \leq 3.5V$ $V_S = \pm 15V$, $V_O = \pm 10V$ $R_L = 25k\Omega$	300	500	—	200	500	—	—	500	—	V/mV
Output Voltage Swing	V_O	$V_+ = 5V$, $V_- = 0V$ $R_L = 10k\Omega$ $V_S = \pm 15V$, $R_L = 25k\Omega$	0.6/4.1	—	—	0.7/4.1	—	—	0.8/4.0	—	—	V
Closed-Loop Bandwidth	BW	$A_{VCL} = +1.0$, $R_L = 10k\Omega$	—	100	—	—	100	—	—	100	—	kHz
Slew Rate	SR	$V_S = \pm 15V$ $R_L = 25k\Omega$	—	0.05	—	—	0.05	—	—	0.05	—	V/ μs
Supply Current	I_{SY}	$V_S = \pm 2.5V$, No Load $V_S = \pm 15V$, No Load	—	40	55	—	44	63	—	45	70	μA
			—	55	80	—	57	85	—	60	95	

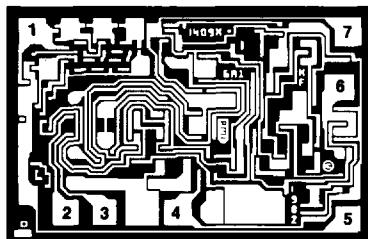
ELECTRICAL CHARACTERISTICS at $V_S = \pm 2.5V$ to $\pm 15V$, $-55^\circ C \leq T_A \leq +125^\circ C$ for OP-20BJ/BZ and OP-20CZ, $-25^\circ C \leq T_A \leq +85^\circ C$ for OP-20FJ/FZ and OP-20GJ/GZ, and $0^\circ C \leq T_A \leq +70^\circ C$ for OP-20FP, OP-20GP, and $-40^\circ C \leq T_A \leq +85^\circ C$ for OP-20HZ, OP-20HJ, and OP-20HP/HS, unless otherwise noted.

PARAMETER	SYMBOL	CONDITIONS	OP-20B/F			OP-20C/G			OP-20H			UNITS
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	
Average Input Offset Voltage Drift (Note 1)	TCV_{OS}	Unnullled	—	0.75	1.5	—	1.0	3.0	—	1.5	7.0	$\mu V/\text{°C}$
Input Offset Voltage	V_{OS}	$V_S = \pm 15V$	—	155	400	—	250	800	—	500	1700	μV
Input Offset Current	I_{OS}	$V_{CM} = 0$	—	0.5	2.5	—	1.0	3.5	—	1.5	5.0	nA
Input Bias Current	I_B	$V_{CM} = 0$	—	12	27	—	14	33	—	16	45	nA
Input Voltage Range	IVR	$V_+ = +5V, V_- = 0V$ $V_S = \pm 15V$	0/3.2 -15/13.2	—	—	0/3.2 -15/13.2	—	—	0/3.2 -15/13.2	—	—	V
Common-Mode Rejection Ratio	$CMRR$	$V_+ = +5V, V_- = 0V$ $0V \leq V_{CM} \leq 3.2V$ $V_S = \pm 15V$ $-15V \leq V_{CM} \leq 13.2V$	90 96	100 110	—	85 90	90 105	—	80 85	85 100	—	dB
Power Supply Rejection Ratio	$PSRR$	$V_S = \pm 2.5V$ to $\pm 15V$ $V_- = 0V$, $V_+ = 5V$ to $30V$	—	4 —	10 —	—	6 —	18 —	—	10 10	32 57	$\mu V/V$
Large-Signal Voltage Gain	A_{VO}	$V_S = \pm 15V, V_O = \pm 10V$ $R_L = 50k\Omega$	500	700	—	400	600	—	250	400	—	V/mV
Output Voltage Swing	V_O	$V_+ = 5V, V_- = 0V$, $R_L = 50k\Omega$ $V_S = \pm 15V$, $R_L = 50k\Omega$	0.8/4.0 ±14.0	— —	— —	0.9/3.9 ±13.9	— —	— —	1.0/3.8 ±13.9	— —	— —	V
Supply Current	I_{SY}	$V_S = \pm 2.5V$, No Load or $+5V, 0V$ $V_S = \pm 15V$, No Load	—	50 —	65 95	—	53 68	75 100	—	55 72	85 115	μA

NOTE:

1. Sample tested.

DICE CHARACTERISTICS



DIE SIZE 0.069×0.046 inch, 3174 sq. mils
(1.75×1.17 mm, 2.05 sq. mm)

1. BALANCE
2. INVERTING INPUT
3. NONINVERTING INPUT
4. V-
5. BALANCE
6. OUTPUT
7. V+

For additional DICE ordering information,
refer to 1990/91 Data Book, Section 2.

WAFER TEST LIMITS at $V_S = \pm 15V$, $T_A = 25^\circ C$, unless otherwise noted.

PARAMETER	SYMBOL	CONDITIONS	OP-20N LIMIT	OP-20G LIMIT	OP-20GR LIMIT	UNITS
Input Offset Voltage	V_{OS}		300	600	1000	μV MAX
Input Offset Current	I_{OS}		1.5	2.5	4.0	nA MAX
Input Bias Current	I_B		25	30	40	nA MAX
Input Voltage Range	IVR	$V_+ = +5V$, $V_- = 0V$ $V_S = \pm 15V$	0/3.5 $-15/13.5$	0/3.5 $-15/13.5$	0/3.5 $-15/13.5$	V MIN
Common-Mode Rejection Ratio	CMRR	$V_+ = +5V$, $V_- = 0V$, $0V \leq V_{CM} \leq +3.5V$ $V_S = \pm 15V$, $-15V \leq V_{CM} \leq \pm 13.5V$	95 100	90 94	85 90	dB MIN
Power Supply Rejection Ratio	PSRR	$V_S = \pm 2.5V$ to $\pm 15V$ $V_- = 0V$, $V_+ = +5V$ to $+30V$	6	10	32	$\mu V/V$ MAX
Large-Signal Voltage Gain	A_{VO}	$R_L = 25k\Omega$ $V_O = \pm 10V$	1000	800	500	V/mV MIN
Output Voltage Swing	V_O	$R_L = 10k\Omega$, $V_+ = +5V$, $V_- = 0V$ $R_L = 25k\Omega$, $V_S = \pm 15V$	0.7/4.1 ± 14.1	0.8/4.1 ± 14.1	0.9/4.0 ± 14.0	V MIN
Supply Current	I_{SY}	$V_S = \pm 2.5V$, No Load $V_S = \pm 15V$, No Load	55 80	63 85	70 95	μA MAX

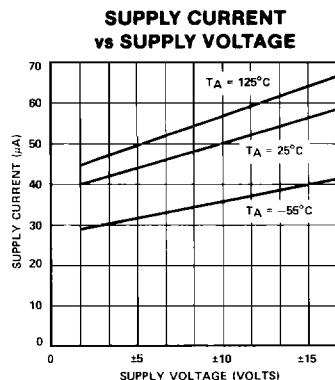
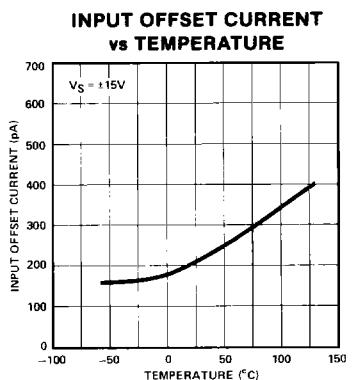
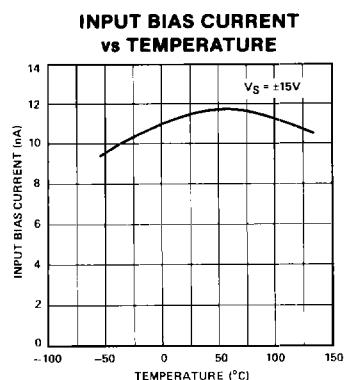
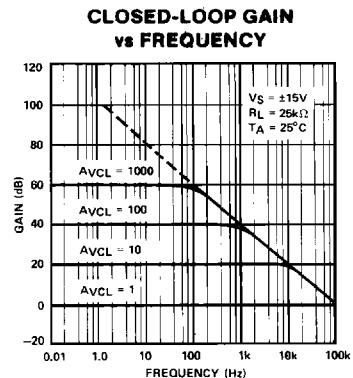
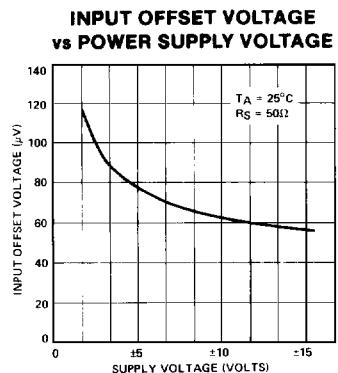
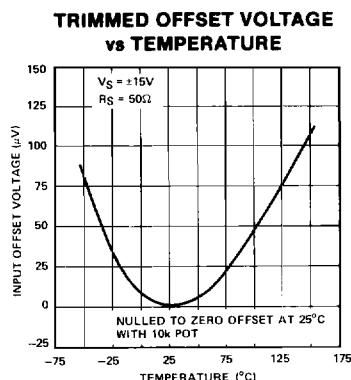
NOTE:

Electrical tests are performed at wafer probe to the limits shown. Due to variations in assembly methods and normal yield loss, yield after packaging is not guaranteed for standard product dice. Consult factory to negotiate specifications based on dice lot qualification through sample lot assembly and testing.

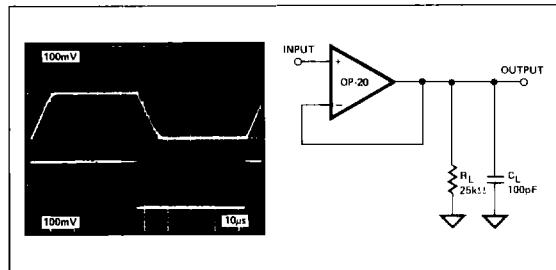
TYPICAL ELECTRICAL CHARACTERISTICS at $V_S = \pm 15V$, $T_A = +25^\circ C$, unless otherwise noted.

PARAMETER	SYMBOL	CONDITIONS	OP-20N TYPICAL	OP-20G TYPICAL	OP-20GR TYPICAL	UNITS
Average Input Offset Voltage Drift	TCV_{OS}	Unnullled	1.0	1.5	2.5	$\mu V/\text{ }^\circ C$
	TCV_{OSn}	Nulled, $R_P = 10k\Omega$	1.0	1.5	2.5	
Large-Signal Voltage Gain	A_{VO}	$R_L = 25k\Omega$	2000	2000	1000	V/mV

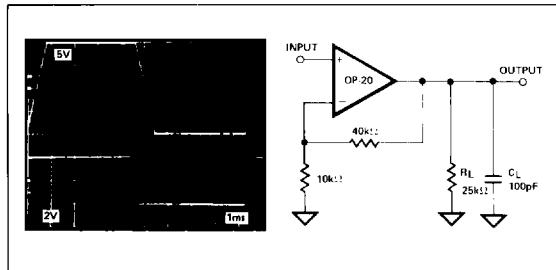
TYPICAL PERFORMANCE CHARACTERISTICS



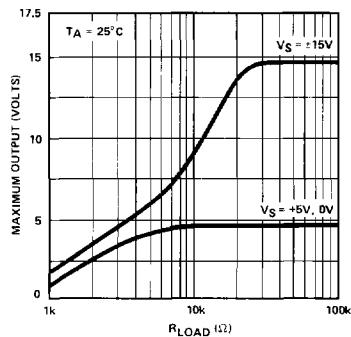
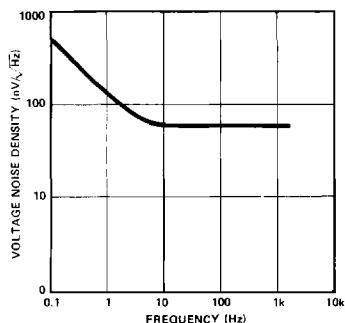
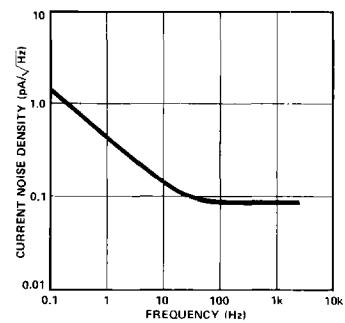
SMALL-SIGNAL TRANSIENT RESPONSE



LARGE-SIGNAL TRANSIENT RESPONSE



TYPICAL PERFORMANCE CHARACTERISTICS

MAXIMUM OUTPUT VOLTAGE
vs LOAD RESISTANCEVOLTAGE NOISE DENSITY
vs FREQUENCYCURRENT NOISE DENSITY
vs FREQUENCY

TYPICAL APPLICATIONS

TEMPERATURE SENSOR

